

YAS529

MS-3C

Magnetic field Sensor

Overview

YAS529 is the Triaxial Geomagnetic Sensor IC integrating buffer amplifier, A/D converter, clock generator, and serial data interface circuit (supports I2C bus) on one chip package.

YAS529 allows you to make up a high sensitive, compact and low-power electronic compass in a portable GPS system or a mobile phone.

■ Features

- A manufacturing process that makes magnetic sensor on Si wafer with high precision realizes integration with peripheral circuits on one chip.
- High sensitive geomagnetic sensor IC is realized by integrating magnetic sensors and low noise amplifiers.
- High noise immunity is improved by digitizing output from geomagnetic sensor IC.
- External interface supports I²C bus (100kbps/400kbps, slave mode).
- Geomagnetic sensor with superior high board density and low-power consumption.
- Automatic power-down control mode is available after geomagnetic measurements.
- Three A/D input pins for an inclination sensor

Manufacturing process

- Power-down control of an inclination sensor with a standby pin by the use of the General-Purpose Output (GPO) Pin
- Others.

| Manufacturing process | CMOS + Magnetic Sensor | | |
|---------------------------------------|--|--|--|
| Package | Lead-free 10-pin WLCSP package (YAS529-PZ) | | |
| Supply voltage for core | 2.5 V to 3.6 V | | |
| Supply voltage for Interface | 1.65 V to VDD (Operating temperature : -20 to +95 °C) | | |
| | 2.30 V to VDD (Operating temperature : -40 to +95 °C) | | |
| Operating temperature | -40 to +95 °C (Supply for the interface : 2.30V to VDD) | | |
| Consumption current during operation. | , 22 2 | | |
| Magnetic field measurement | 4 mA (VDD = 3.0 V) | | |
| Magnetic sensor section | | | |
| Measuring magnetic field range | $\pm 300~\mu T$ | | |
| Resolution | $\leq 0.6 \mu\text{T/count}(X,Y), \leq 1.2 \mu\text{T/count}(Z)$ | | |
| Measuring time | | | |
| Magnetic sensor measurement | within 10 ms (Three axes collective measurement) | | |
| Inclination sensor A/D | within 10 ms (Three axes collective measurement) | | |
| | | | |

CMOS + Magnetia Sensor



YAS529 CATALOG

CATALOG No.: LSI-BAS529A20

2007.6

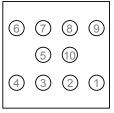


■ Pin Description

Here are figures for pin assignment and a table for pin descriptions.







10-pin WLCSP Bottom View

Pin Descriptions

| Pin No. | Pin Name | I/O | Function |
|---------|----------|------|--|
| 1 | GPO | О | General-purpose output pin |
| 2 | VSS | - | Ground |
| 3 | AIZ | A | A/D input 3 |
| 4 | AIX | A | A/D input 1 |
| 5 | AIY | A | A/D input 2 |
| 6 | VDD | - | Power supply for core (Typ. 3 V) |
| 7 | SDA | I/Od | Serial data |
| 8 | SCL | I | Serial clock |
| 9 | IOVDD | - | Power supply for interface (Typ. 1.8V) |
| 10 | RSTN | Is | Device initialization |

Note)

Connecting AIZ to VDD is recommended when used by connecting a biaxial inclination sensor. When the inclination sensor is not used, connecting AIX, AIY, and AIZ to VSS is recommended. No Schmitt circuit is used for SCL and SDA input pins.

A : Analog input
I : Digital input
Is : Schmitt input
Od : Open drain output

O : Output



■ Pin Functions

• Power Supply (VDD, IOVDD, VSS)

These pins are for power supply of YAS529.

VDD : Power Supply for core IOVDD : Power Supply for the Interface

VSS : Ground

• Serial Data Interface (SCL, SDA, RSTN, GPO)

SCL : Serial clock input pin

These pins are used with an external pull-up resistor.

SDA : Serial data input/output pin

These pins are used with an external pull-up resistor.

RSTN : Serial data interface reset pin

"L" releases I2C bus.

When not used, connect to IOVDD pin.

GPO : General-purpose output pin

Analog Input

AIX, AIY, AIZ: A/D input pin

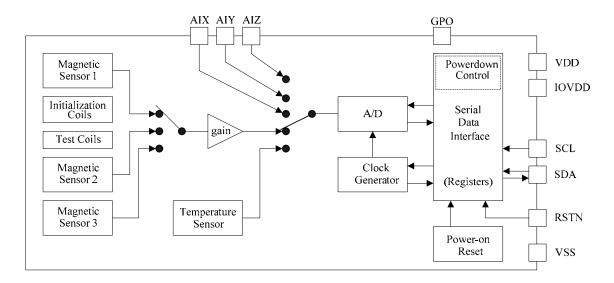
Connecting AIZ to VDD is recommended when used by connecting a biaxial inclination sensor.

When the inclination sensor is not used, connecting AIX, AIY, and AIZ to VSS is recommended.



■ Block Diagram

Here is the internal block diagram of YAS529.



Block Diagram



■ Function Descriptions

Analog Circuit Section

O Magnetic Sensor

YAS529 includes three Magnetic Sensors.

Only the sensor of an axis to measure at the time of magnetic field measurement is operated.

O Buffer Amplifier

The buffer amplifier amplifies a signal output from the bridge of magnetic sensor.

The amplifier operates only when magnetic field measurement is made.

O Temperature Sensor

This is the sensor to correct the temperature characteristics of the magnetic sensor.

The sensor operates only when temperature is measured.

O A/D Converter (ADC)

The A/D converter converts input signals from magnetic sensor output amplified by the buffer amplifier, temperature sensor output, and external input pin.

The converter operates only when a measurement is performed.

O Clock Generator

The clock generator supplies clocks to ADC and digital circuits.

The generator operates only when a measurement is performed.

O Power-on Reset

The Power-on Reset circuit detects a rising edge of the supply voltage for the core and initializes the circuits.

Initialization Coil

The coils are used when the magnetic sensor cannot exert the original characteristics due to receiving high magnetic field.

Generating magnetic field with the initialization coils initializes the magnetic sensor characteristics.

O Analog External Input A/D

The A/D measures values from analog external input.

Input range is from 0.5 to 2.5V. One count of A/D converter is about 3.0mV.



• Digital Circuit Section

O Serial Data Interface

YAS529 serial data interface supports I²C bus serial interface and operates in the slave mode.

SCL (SCL) : Serial clock input pin SDA (SDA) : Serial data input/output pin Communication is performed through the above pins.

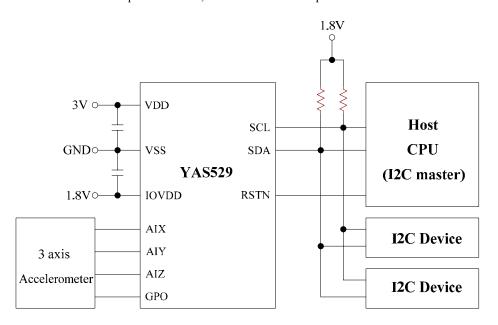
O General-Purpose Output (GPO) Pin

YAS529 has GPO as general-purpose output pin. This output pin can be used for purposes such as power-down control of an inclination sensor with standby pin.

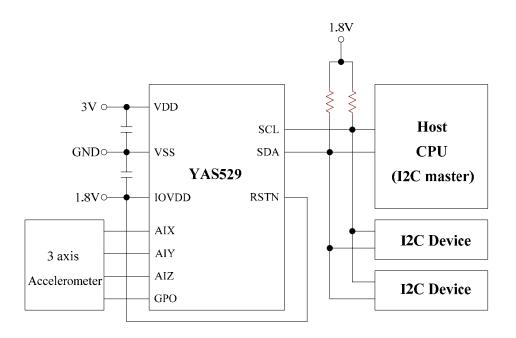


■ Example of System Configuration

Here is an example of system configuration. When RSTN pin is not used, connect it to IOVDD pin.



Example of system configuration



Example of system configuration (RSTN pin is not used)



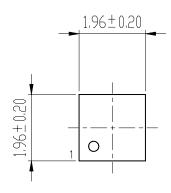
■ Package Outline Drawing

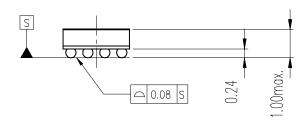
Caution

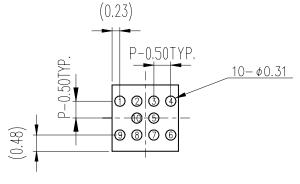
- * The product of the WLCSP package should be used under light-shielded conditions.

 Since the WLCSP package has a structure that a silicon wafer is exposed, if light (such as sunlight) hits the wafer, the device may malfunction (leak current increase etc.) due to electric charge internally generated by the photoelectric effect.
- * Please mount the package without underfill because temperature correction may not be normally performed when mounting YAS529 on a board.

C-PK10PP-1







カッコ内の寸法値は参考値です。 外形寸法はバリを含みます。

単位:mm

The figure in the parentheses () should be used as a reference.

The dimensions include burr.

UNIT: mm

注) 表面実装LSIは、保管条件、及び半田付けについての特別な配慮が必要です。 詳しくはヤマハ代理店までお問い合わせください。

Note: The storage and soldering of LSIs for surface mounting need special consideration. For detailed information, please contact your local Yamaha agent.

YAS529



МЕМО



IMPORTANT NOTICE

- 1. YAMAHA RESERVES THE RIGHT TO MAKE CHANGES TO ITS PRODUCTS AND TO THIS DOCUMENT WITHOUT NOTICE. THE INFORMATION CONTAINED IN THIS DOCUMENT HAS BEEN CAREFULLY CHECKED AND IS BELIEVED. HOWEVER, YAMAHA SHALL ASSUME NO RESPONSIBILITIES FOR INACCURACIES AND MAKE NO COMMITMENT TO UPDATE OR TO KEEP CURRENT THE INFORMATION CONTAINED IN THIS DOCUMENT.
- 2. THESE YAMAHA PRODUCTS ARE DESIGNED ONLY FOR COMMERCIAL AND NORMAL INDUSTRIAL APPLICATIONS, AND ARE NOT SUITABLE FOR OTHER USES, SUCH AS MEDICAL LIFE SUPPORT FOUIPMENT. NUCLEAR FACILITIES, CRITICAL CARE EQUIPMENT OR ANY OTHER APPLICATION THE FAILURE OF WHICH COULD LEAD TO DEATH, PERSONAL INJURY OR ENVIRONMENTAL OR PROPERTY DAMAGE. USE OF THE PRODUCTS IN ANY SUCH APPLICATION IS AT THE CUSTOMER'S OWN RISK AND EXPENSE.
- 3. YAMAHA SHALL ASSUME NO LIABILITY FOR INCIDENTAL, CONSEQUENTIAL OR SPECIAL DAMAGES OR INJURY THAT MAY RESULT FROM MISAPPLICATION OR IMPROPER USE OR OPERATION OF THE PRODUCT.
- 4 YAMAHA MAKES NO WARRANTY OR REPRESENTATION THAT THE PRODUCTS ARE SUBJECT TO INTELLECTUAL PROPERTY LICENSE FROM YAMAHA OR ANY THIRD PARTY, AND YAMAHA MAKES NO WARRANTY OR REPRESENTATION OF NON-INFRINGEMENT WITH RESPECT TO THE PRODUCTS, YAMAHA SPECIFICALLY EXCLUDES ANY LIABILITY TO THE CUSTOMER OR ANY THIRD PARTY ARISING FROM OR RELATED TO THE PRODUCTS INFRINGEMENT OF ANY THIRD PARTY'S INTELLECTUAL PROPERTY RIGHTS, INCLUDING THE PATENT, COPYRIGHT, TRADEMARK OR TRADE SECRET RIGHTS OF ANY THIRD PARTY.
- 5. EXAMPLES OF USE DESCRIBED HEREIN ARE MERELY TO INDICATE THE CHARACTERISTICS AND PERFORMANCE OF PRODUCTS. YAMAHA SHALL ASSUME NO RESPONSIBILITY FOR ANY INTELLECTUAL PROPERTY CLAIMES OR OTHER PROBLEMS THAT MAY RESULT FROM APPLICATIONS BASED ON THE EXAMPLES DESCRIBED HEREIN. YAMAHA MAKES NO WARRANTY WITH RESPECT TO THE PRODUCTS, EXPRESS OR IMPLIED, INCLUDING, BUT NOT LIMITED TO THE WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR USE AND TITLE.
- 6. YAMAHA MAKES EVERY EFFORT TO IMPROVE THE QUALITY AND RELIABILITY OF ITS PRODUCTS. HOWEVER. ALL SEMICONDUCTOR PRODUCTS FAIL WITH SOME PROBABILITY. THEREFORE, YAMAHA REQUIRES THAT SUFFICIENT CARE BE GIVEN TO ENSURING SAFE DESIGN IN CUSTOMER PRODUCTS SUCH AS REDUNDANT DESIGN, ANTI-CONFLAGRATION DESIGN, AND DESIGN FOR PREVENTING MALFUNCTION IN ORDER TO PREVENT ACCIDENTS RESULTING IN INJURY OR DEATH, FIRE OR OTHER SOCIAL DAMAGE FROM OCCURRING AS A RESULT OF PRODUCT FAILURE.
- 7. INFORMATION DESCRIBED IN THIS DOCUMENT: APPLICATION CIRCUITS AND ITS CONSTANTS AND CALCULATION FORMULAS, PROGRAMS AND CONTROL PROCEDURES ARE PROVIDED FOR THE PURPOSE OF EXPLAINING TYPICAL OPERATION AND USAGE. THEREFORE, PLEASE EVALUATE THE DESIGN SUFFICIENTLY AS WHOLE SYSTEM UNDER THE CONSIDERATION OF VARIOUS EXTERNAL OR ENVIRONMENTAL CONDITIONS AND DETERMINE THEIR APPLICATION AT THE CUSTOMER'S OWN RISK. YAMAHA SHALL ASSUME NO RESPONSIBILITY FOR CLAIMS, DAMAGES, COSTS AND EXPENSES CAUSED BY THE CUSTOMER OR ANY THIRD PARTY, OWING TO THE USE OF THE ABOVE INFORMATION.

Notice The specifications of this product are subject to improvement changes without prior notice.

| | ——— YAIVIAHA CORPORATION ——— | |
|-------|---|--|
| AGENT | Address inquiries to: Semiconductor Sales & Marketing Department | |
| | ■ Head Office | 203, Matsunokijima, Iwata, Shizuoka, 438-0192, Japan Tel. +81-539-62-4918 Fax. +81-539-62-5054 |
| | ■ Tokyo Office | 2-17-11, Takanawa, Minato-ku, Tokyo, 108-8568, Japan Tel. +81-3-5488-5431 Fax. +81-3-5488-5088 |
| | ■ Osaka Office | 3-12-12, Minami Senba, Chuo-ku, Osaka City, Osaka, 542-0081, Japan Tel. +81-6-6252-6221 Fax. +81-6-6252-6229 |
| \ | | |